DECEMBER 1983 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

These devices contain four independent 2-input OR gates.

The SN5432, SN54LS32 and SN54S32 are characterized for operation over the full military range of  $-55\,^{\circ}\text{C}$  to  $125\,^{\circ}\text{C}$ . The SN7432, SN74LS32 and SN74S32 are characterized for operation from  $0\,^{\circ}\text{C}$  to  $70\,^{\circ}\text{C}$ .

**FUNCTION TABLE (each gate)** 

INP	UTS	OUTPUT
Α	В	Y
Н	х	н
Х	н	H
L	L	L

#### logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D. J. N. or W packages.

SN5432, SN54LS32, SN54S32 . . . J OR W PACKAGE SN7432 . . . N PACKAGE SN74LS32, SN74S32 . . . D OR N PACKAGE (TOP VIEW)

1A [[ī	U14 VCC
1B <u>□</u> 2	13 <b>□</b> 4B
1Y □3	12 4A
2A	11 🕽 4Y
2B 🗖 5	10 3B
2Y ☐ 6	9∐-3A
GND 🗖 7	8 3Y

SN54LS32, SN54S32 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### logic diagram



#### positive logic

 $Y = A + B \text{ or } Y = \overline{\overline{A \cdot B}}$ 

#### schematics (each gate)







Resistor values shown are nominal.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7 V
Input voltage: '32, 'S32	5.5 V
'L\$32	7 V
Operating free-air temperature: SN54'	. –55°C to 125°C
SN74′	0°C to 70°C
Storage temperature range	, -65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

# recommended operating conditions

		SN5432	?		UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	ONT
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH Hgh-level input voltage	2			2			V
VIL Low-level imput voltage			8.0			8,0	V
OH High-level output current			- 0.8			<b>- 0.8</b>	mA
IOL Low-level output current			16			16	mΑ
TA Operating free-air temperature	- 55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS +			SN5432			SN7432			
PANAMETER		TEST CONDITIONS †			TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	VCC = MIN,	lj = - 12 mA				- 1.5			<b>— 1.5</b>	V
V <sub>QH</sub>	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	l <sub>OH</sub> = − 0,8 mA	2.4	3.4		2.4	3.4		V
VOL	V <sub>CC</sub> = MIN,	V <sub>1</sub> L ≈ 0.8 V,	IOL = 16 mA		0,2	0.4		0.2	0.4	· V
l <sub>l</sub>	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				1			1	mΑ
<del>Пн</del>	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.4 V				40			40	μΑ
lin.	V <sub>CC</sub> = MAX,	$V_1 = 0.4 \ V$				1.6			- 1.6	mΑ
OS§	V <sub>CC</sub> = MAX	•		- 20		<b>– 55</b>	- 18		- 55	mΑ
Іссн	V <sub>CC</sub> = MAX,	See Note 2			15	22		15	22	mΑ
<sup> </sup> CCL	V <sub>CC</sub> = MAX,	V1 = 0 V			23	38		23	38	mΑ

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	MAX	UNIT	
tPLH !	A or B	>	B 400 O	C - 15 - 5		10	15	ns
†PHL	A 01 B	<u> </u>	$R_L = 400 \Omega$ ,	C <sub>L</sub> = 15 pF		14	22	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C. § Not more than one output should be shorted at a time.

# SN54LS32, SN74LS32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

#### recommended operating conditions

		SN54LS32		SN74LS	S32	
	MIN	NOM MA	X MIN	NOM	5 5.25 0.8	UNIT
V <sub>CC</sub> Supply voltage	4.5	5 <b>5</b>	5 4.75	5	5.25	V
V <sub>IH</sub> Hgh-level input voltage	2		7 2			V
VIL Low-level input voltage		0.	7		8.0	V
IOH High-level output current		<b>–</b> 0.	4		D.4	mA
IOL Low-level output current			4		8	mA
TA Opertating free-air temperature	- 55	12	5 0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	·				SN54LS	32		32	UNIT	
PARAMETER		TEST CONDIT	TONST	MIN	TYP‡	MAX	MIN	TYP ‡	MAX	UNII
V <sub>IK</sub>	V <sub>CC</sub> - MIN,	I <sub>1</sub> = 18 mA			·	- 1.5			- 1.5	V
∨он	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OH</sub> = - 0.4 mA	2,5	3.4	•	2.7	3.4		V
	VCC = MIN,	VIL = MAX,	IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	V <sub>CC</sub> = MIN,	VIL = MAX,	ioL = 8 mA	i			[	0.35	0.5	\ \
Ιι	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V		1		0.1			0.1	mA
IH	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V	<u> </u>		•	20			20	μА
HL	VCC = MAX,	V1 = 0.4 V		ļ		0.4			- 0.4	mΑ
105§	VCC = MAX			- 20		- 100	<b>– 20</b>		<b>- 100</b>	mΑ
іссн	V <sub>CC</sub> = MAX,	See Note 2			3,1	6.2	Ü	3.1	6.2	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0 V			4.9	9.8		4.9	9.8	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

#### switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	TEST CONDITIONS				UNIT
tPLH	A or B	V	D - 21.0	C = 15 ==		14	22	пѕ
t <b>P</b> HL	A OF B	T	$R_L = 2 k\Omega$ ,	C <sub>L</sub> = 15 p <sub>F</sub>		14	22	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

#### recommended operating conditions

			SN54S32			SN74S32			
		MIN	MOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧	
ViH	High-level input voltage	2			2			V	
VIL	Low-level input voltage			8.0			0.8	V	
Іон	High-level output current			1			_ 1	mA	
lOL	Low-level output current			20			20	mA	
TA	Operating free-air temperature	<b>– 55</b>		125	0		70	°C	

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT	HONE T		SN54S3	2		SN74S3	2	
PARAMETER		TEST CONDITIONS :				MAX	MIN	TYP #	MAX	UNIT
v <sub>IK</sub>	VCC = MIN,	lj = _ 18 mA	<del></del>			- 1.2	[		- 1.2	V
VOH	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OH</sub> = - 1 mA	2.5	3.4		2.7	3.4		V
Vol	VCC = MIN,	V <sub>IL</sub> = 0.8 V,	I <sub>OL</sub> = 20 mA			0.5			0.5	V
Ч	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				1		-	1	mA
ЧН	VCC = MAX,	V <sub>1</sub> = 2.7 V				50			50	μА
ΊL	VCC = MAX,	V <sub>1</sub> = 0.5 V				-2			- 2	mA
los§	V <sub>CC</sub> = MAX			- 40		<b>- 100</b>	- 40		<b>–</b> 100	mA
Гссн	V <sub>CC</sub> = MAX,	See Note 2			18	32		18	32	mΑ
ICCL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0 V			38	68	1	38	68	mA

- † For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
- ‡ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. § Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.
- NOTE 2: One input at 4.5 V, all others at GND.

# switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN T	ΥP	MAX	UNIT	
tPLH .	A == D	· ·	D - 370 C	C <sub>1</sub> = 15 pF		4	7	ns
tPHL	A or B	,	R <sub>L</sub> = 280 Ω,	C[ = 15 pr		4	7	ns
tPLH	A or 8		$R_1 = 280 \Omega$ ,	C <sub>I</sub> = 50 pF		5		пş
tPHL	A 01 8	'	71_ 200 32,	OL 30 M		5		ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.





www.ti.com 16-Feb-2023

# **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9557401QCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QC A SNJ5432J	Samples
5962-9557401QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Samples
5962-9557401QDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Samples
JM38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples
JM38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples
JM38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Samples
JM38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Samples
JM38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BDA	Samples
JM38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BDA	Samples
JM38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Samples
JM38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Samples
JM38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Samples
JM38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Samples
M38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples
M38510/30501B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501B2A	Samples





www.ti.com

16-Feb-2023

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
M38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Samples
M38510/30501BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BCA	Samples
M38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BDA	Samples
M38510/30501BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501BDA	Samples
M38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Samples
M38510/30501SCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SCA	Samples
M38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Samples
M38510/30501SDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30501SDA	Samples
SN5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5432J	Samples
SN5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5432J	Samples
SN54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS32J	Samples
SN54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS32J	Samples
SN54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S32J	Samples
SN54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S32J	Samples
SN7432N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7432N	Samples
SN7432N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7432N	Samples
SN7432NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7432N	Samples
SN7432NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7432N	Samples





16-Feb-2023 www.ti.com

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DBR	ACTIVE	SSOP	DB	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DBR	ACTIVE	SSOP	DB	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DE4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DE4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DG4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DG4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRE4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32DRG4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS32	Samples
SN74LS32N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS32N	Samples
SN74LS32NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Samples
SN74LS32NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Samples
SN74LS32NSRG4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Samples





16-Feb-2023 www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS32NSRG4	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS32	Samples
SN74S32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S32	Samples
SN74S32D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S32	Samples
SN74S32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S32	Samples
SN74S32DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S32	Samples
SN74S32N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S32N	Samples
SN74S32N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S32N	Samples
SNJ5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QC A SNJ5432J	Samples
SNJ5432J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QC A SNJ5432J	Samples
SNJ5432W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Samples
SNJ5432W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9557401QD A SNJ5432W	Samples
SNJ54LS32FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 32FK	Samples
SNJ54LS32FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 32FK	Samples
SNJ54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS32J	Samples
SNJ54LS32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS32J	Samples
SNJ54LS32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS32W	Samples
SNJ54LS32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS32W	Samples



www.ti.com 16-Feb-2023

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32J	Samples
SNJ54S32J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32J	Samples
SNJ54S32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32W	Samples
SNJ54S32W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S32W	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE OPTION ADDENDUM

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN5432, SN54LS32, SN54LS32-SP, SN54S32, SN7432, SN74LS32, SN74LS32:

Catalog: SN7432, SN74LS32, SN54LS32, SN74S32

Military: SN5432, SN54LS32, SN54S32

• Space : SN54LS32-SP

#### NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

• Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 9-Aug-2022

#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS32DBR	SSOP	DB	14	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
SN74LS32DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS32NSR	so	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74S32DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



www.ti.com 9-Aug-2022



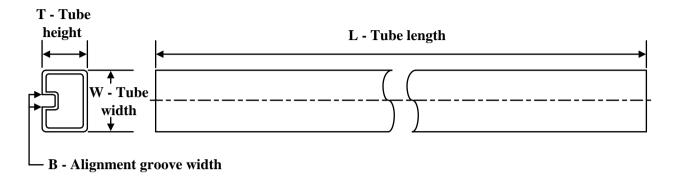
#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS32DBR	SSOP	DB	14	2000	356.0	356.0	35.0
SN74LS32DR	SOIC	D	14	2500	356.0	356.0	35.0
SN74LS32NSR	so	NS	14	2000	356.0	356.0	35.0
SN74S32DR	SOIC	D	14	2500	356.0	356.0	35.0



www.ti.com 9-Aug-2022

#### **TUBE**



#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-9557401QDA	W	CFP	14	1	506.98	26.16	6220	NA
JM38510/30501B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/30501BDA	W	CFP	14	1	506.98	26.16	6220	NA
JM38510/30501SDA	W	CFP	14	1	506.98	26.16	6220	NA
M38510/30501B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/30501BDA	W	CFP	14	1	506.98	26.16	6220	NA
M38510/30501SDA	W	CFP	14	1	506.98	26.16	6220	NA
SN7432N	N	PDIP	14	25	506	13.97	11230	4.32
SN7432N	N	PDIP	14	25	506	13.97	11230	4.32
SN7432NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN7432NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS32D	D	SOIC	14	50	506.6	8	3940	4.32
SN74LS32DE4	D	SOIC	14	50	506.6	8	3940	4.32
SN74LS32DG4	D	SOIC	14	50	506.6	8	3940	4.32
SN74LS32N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS32N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS32NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS32NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74S32D	D	SOIC	14	50	506.6	8	3940	4.32
SN74S32N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S32N	N	PDIP	14	25	506	13.97	11230	4.32
SNJ5432W	W	CFP	14	1	506.98	26.16	6220	NA
SNJ54LS32FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS32W	W	CFP	14	1	506.98	26.16	6220	NA
SNJ54S32W	W	CFP	14	1	506.98	26.16	6220	NA

# **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# W (R-GDFP-F14)

# CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
  Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# DB (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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